### Table

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<td>16</td>
<td>X</td>
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</table>

**Layer Name**: 1  TOP/Layer1/Bottom

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**Overall Board Thickness**: 62 mil

**Soldermask Color**: Red

**Silkscreen Color**: White

**Drill hole tolerance**: +/-3 mil

**Copper/Spacing Clearances**: 5/5 mil

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<table>
<thead>
<tr>
<th>COMPANY</th>
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<tr>
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<tr>
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